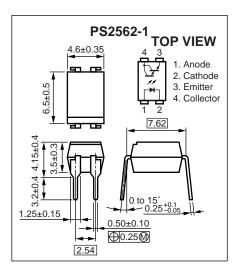
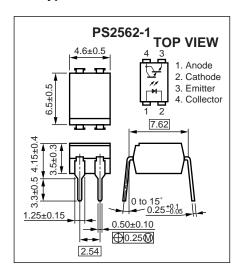
## **★** PACKAGE DIMENSIONS (UNIT : mm)

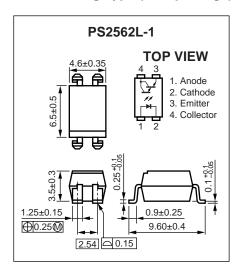
## **DIP Type (New package)**



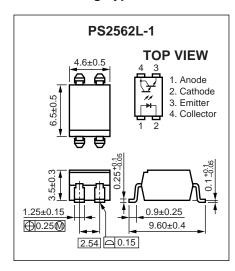
## **DIP Type**



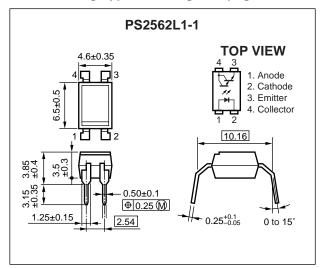
## Lead Bending Type (New package)



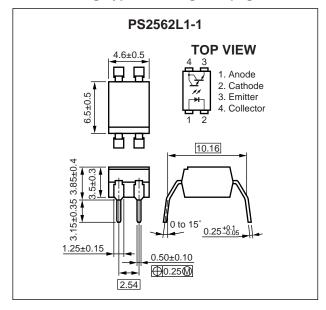
## **Lead Bending Type**



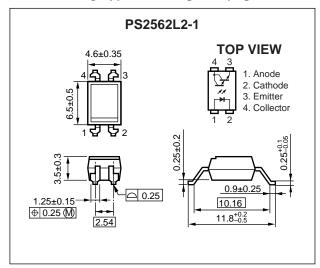
## Lead Bending Type For Long Creepage Distance (New Package)



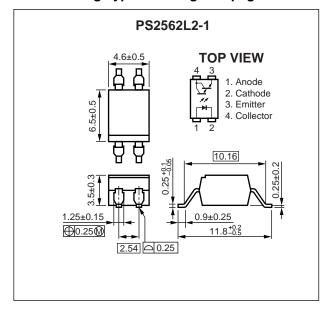
## **Lead Bending Type For Long Creepage Distance**



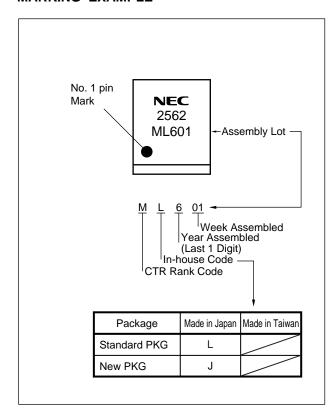
## Lead Bending Type For Long Creepage Distance (Gull-Wing) (New Package)



## Lead Bending Type For Long Creepage Distance (Gull-Wing)



#### **★ MARKING EXAMPLE**



## **★ ORDERING INFORMATION**

| Part Number     | Order Number      | Solder Plating<br>Specification | Packing Style                | Safety Standard<br>Approval | Application Part Number*1 |
|-----------------|-------------------|---------------------------------|------------------------------|-----------------------------|---------------------------|
| PS2562-1        | PS2562-1-A        | Pb-Free                         | Magazine case 100 pcs        | Standard products           | PS2562-1                  |
| PS2562L-1       | PS2562L-1-A       |                                 |                              | (UL, CSA, BSI,              |                           |
| PS2562L1-1      | PS2562L1-1-A      |                                 |                              | NEMKO, SEMKO,               |                           |
| PS2562L2-1      | PS2562L2-1-A      |                                 |                              | DEMKO, FIMKO                |                           |
| PS2562L-1-E3    | PS2562L-1-E3-A    |                                 | Embossed Tape 1 000 pcs/reel | approved)                   |                           |
| PS2562L-1-E4    | PS2562L-1-E4-A    |                                 |                              |                             |                           |
| PS2562L-1-F3    | PS2562L-1-F3-A    |                                 | Embossed Tape 2 000 pcs/reel |                             |                           |
| PS2562L-1-F4    | PS2562L-1-F4-A    |                                 |                              |                             |                           |
| PS2562L2-1-E3   | PS2562L2-1-E3-A   |                                 | Embossed Tape 1 000 pcs/reel |                             |                           |
| PS2562L2-1-E4   | PS2562L2-1-E4-A   |                                 |                              |                             |                           |
| PS2562-1-V      | PS2562-1-V-A      |                                 | Magazine case 100 pcs        | DIN EN60747-5-2             |                           |
| PS2562L-1-V     | PS2562L-1-V-A     |                                 |                              | (VDE0884 Part2)             |                           |
| PS2562L1-1-V    | PS2562L1-1-V-A    |                                 |                              | approved                    |                           |
|                 |                   |                                 |                              | products                    |                           |
| PS2562L2-1-V    | PS2562L2-1-V-A    |                                 |                              | (option)                    |                           |
| PS2562L-1-V-E3  | PS2562L-1-V-E3-A  |                                 | Embossed Tape 1 000 pcs/reel |                             |                           |
| PS2562L-1-V-E4  | PS2562L-1-V-E4-A  |                                 |                              |                             |                           |
| PS2562L-1-V-F3  | PS2562L-1-V-F3-A  |                                 | Embossed Tape 2 000 pcs/reel |                             |                           |
| PS2562L-1-V-F4  | PS2562L-1-V-F4-A  |                                 |                              |                             |                           |
| PS2562L2-1-V-E3 | PS2562L2-1-V-E3-A |                                 | Embossed Tape 1 000 pcs/reel |                             |                           |
| PS2562L2-1-V-E4 | PS2562L2-1-V-E4-A | _                               |                              |                             |                           |

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

## **★** ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)

|                                 | Parameter                    | Symbol           | Ratings     | Unit    |
|---------------------------------|------------------------------|------------------|-------------|---------|
| Diode                           | Reverse Voltage              | VR               | 6           | V       |
|                                 | Forward Current (DC)         | lF               | 80          | mA      |
|                                 | Power Dissipation Derating   | ⊿P₀/°C           | 1.5         | mW/°C   |
|                                 | Power Dissipation            | Po               | 150         | mW      |
|                                 | Peak Forward Current*1       | <b>I</b> FP      | 1           | Α       |
| Transistor                      | Collector to Emitter Voltage | Vceo             | 40          | V       |
|                                 | Emitter to Collector Voltage | Veco             | 6           | V       |
|                                 | Collector Current            | lc               | 200         | mA      |
|                                 | Power Dissipation Derating   | ⊿Pc/°C           | 2.0         | mW/°C   |
|                                 | Power Dissipation            | Pc               | 200         | mW      |
| Isolation Voltage <sup>*2</sup> |                              | BV               | 5 000       | Vr.m.s. |
| Operating Ambient Temperature   |                              | TA               | -55 to +100 | °C      |
| Storage Temperature             |                              | T <sub>stg</sub> | -55 to +150 | °C      |

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1%

<sup>\*2</sup> AC voltage for 1 minute at  $T_A = 25$ °C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.

# CEL California Eastern Laboratories PS2562-1,PS2562L-1,PS2562L1-1,PS2562L2-1

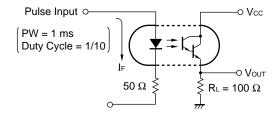
## **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

|            | Parameter                            | Symbol           | Conditions  | MIN.             | TYP.  | MAX. | Unit |
|------------|--------------------------------------|------------------|---|------------------|-------|------|------|
| Diode      | Forward Voltage                      | VF               | IF = 10 mA  |                  | 1.17  | 1.4  | V    |
|            | Reverse Current                      | lR               | V <sub>R</sub> = 5 V  |                  |       | 5    | μА   |
|            | Terminal Capacitance                 | Ct               | V = 0 V, f = 1.0 MHz  |                  | 50    |      | pF   |
| Transistor | Collector to Emitter Dark<br>Current | Iceo             | VcE = 40 V, IF = 0 mA   |                  |       | 400  | nA   |
| Coupled    | Current Transfer Ratio               | CTR              | IF = 1 mA, VcE = 2 Vcc  | 200              | 2 000 |      | %    |
|            | Collector Saturation<br>Voltage      | VCE(sat)         | I <sub>F</sub> = 1 mA, I <sub>C</sub> = 2 mA                              |                  |       | 1.0  | V    |
|            | Isolation Resistance                 | R <sub>I-O</sub> | Vi-o = 1.0 kVpc   | 10 <sup>11</sup> |       |      | Ω    |
|            | Isolation Capacitance                | C <sub>I-O</sub> | V = 0 V, f = 1.0 MHz  |                  | 0.5   |      | pF   |
|            | Rise Time*2                          | tr               | $Vcc = 10 \text{ V}, \text{ Ic} = 10 \text{ mA}, \text{ RL} = 100 \Omega$ |                  | 100   |      | μS   |
|            | Fall Time*2                          | <b>t</b> f       |   |                  | 100   |      |      |

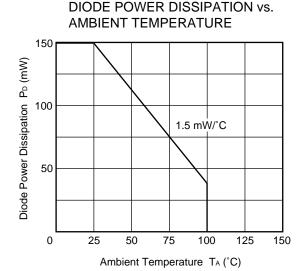
#### ★ \*1 CTR rank

K : 2 000 to (%) L : 700 to 3 400 (%) M : 200 to 1 000 (%)

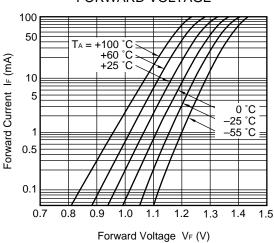
\*2 Test circuit for switching time



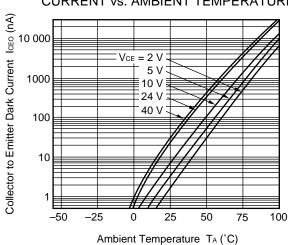
#### TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)



### FORWARD CURRENT vs. FORWARD VOLTAGE

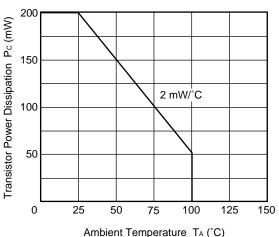


#### COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

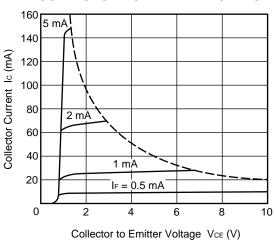


#### Remark The graphs indicate nominal characteristics.

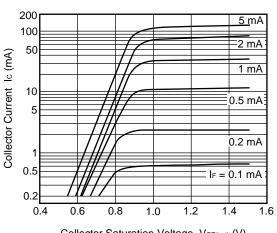
## TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



### COLLECTOR CURRENT vs. **COLLECTOR TO EMITTER VOLTAGE**

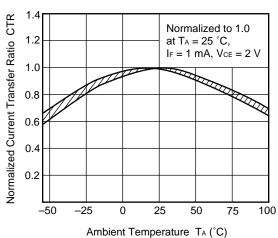


#### COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**

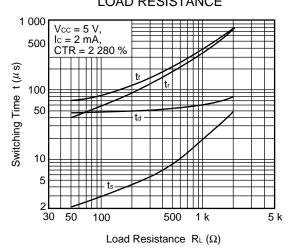


Collector Saturation Voltage VcE(sat) (V)

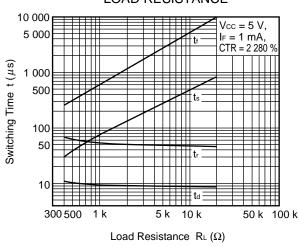
# NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



## SWITCHING TIME vs. LOAD RESISTANCE

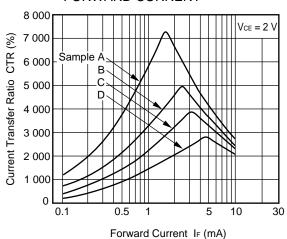


# SWITCHING TIME vs. LOAD RESISTANCE

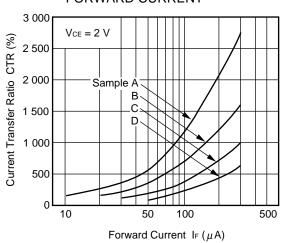


#### Remark The graphs indicate nominal characteristics.

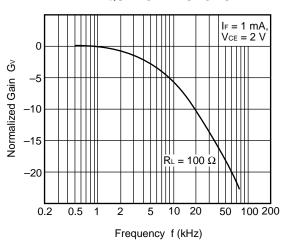
# CURRENT TRANSFER RATIO vs. FORWARD CURRENT



# CURRENT TRANSFER RATIO vs. FORWARD CURRENT



#### FREQUENCY RESPONSE

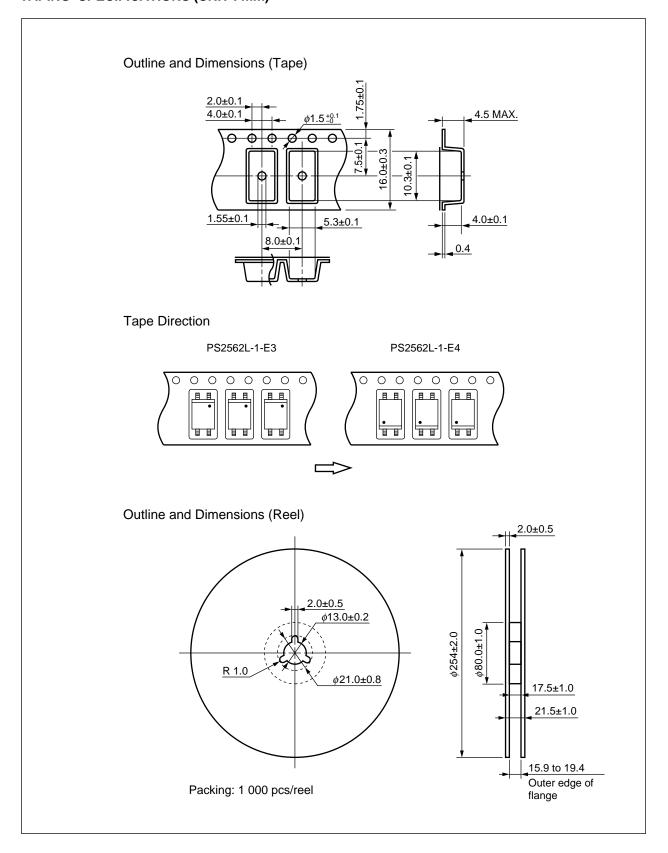


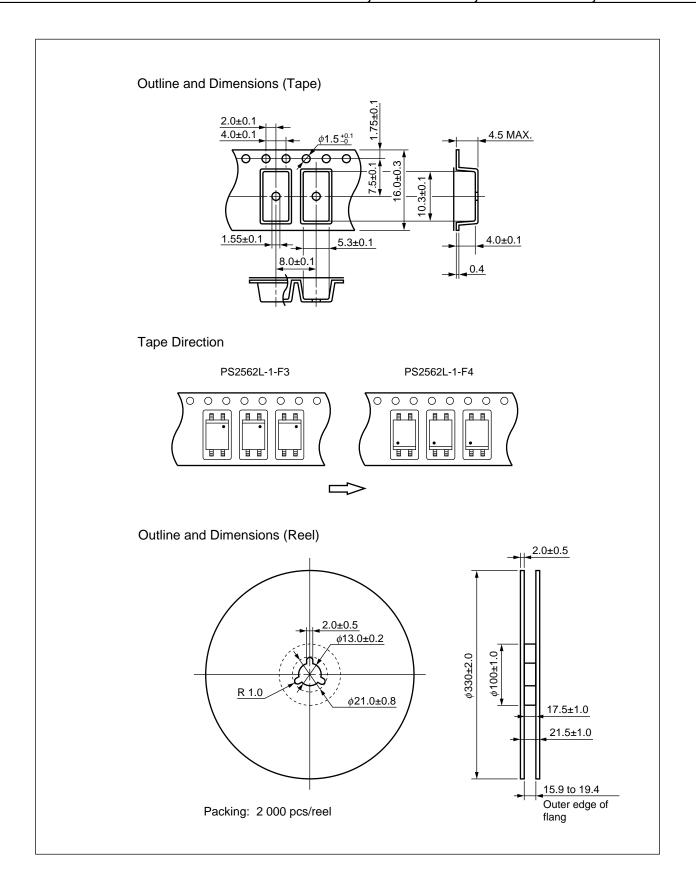
#### LONG TERM CTR DEGRADATION 1.2 $I_F = 1 \text{ mA}$ 1.0 CTR (Relative Value) T<sub>A</sub> = 25 °C 0.8 T<sub>A</sub> = 60 °C 0.6 0.4 0.2 0 10<sup>2</sup> 10<sup>3</sup> 10<sup>4</sup> 10<sup>5</sup> 10<sup>6</sup> 10

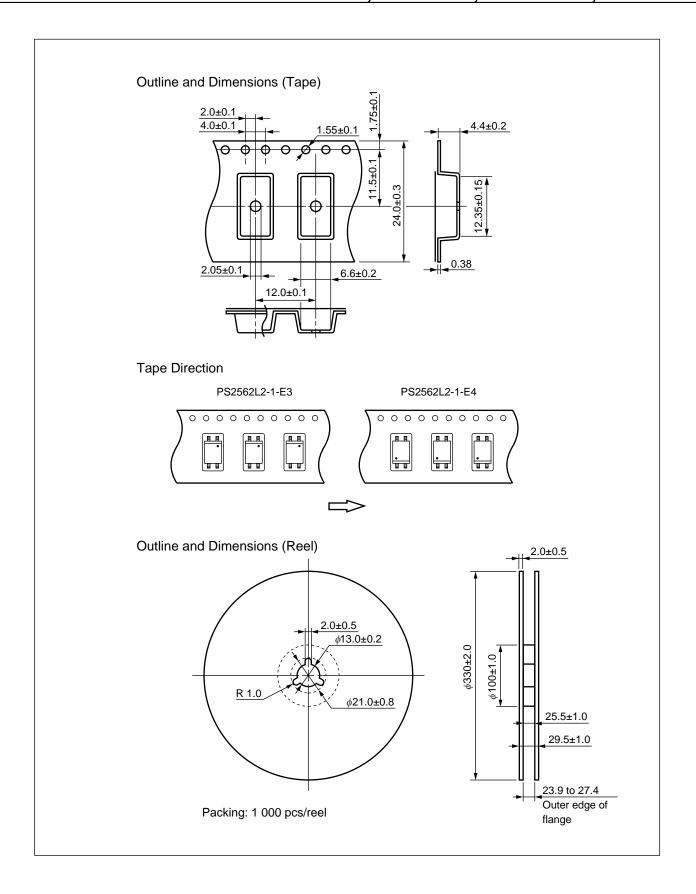
**Remark** The graph indicates nominal characteristics.

Time (Hr)

## **★ TAPING SPECIFICATIONS (UNIT : mm)**







#### **NOTES ON HANDLING**

#### 1. Recommended soldering conditions

## (1) Infrared reflow soldering

· Peak reflow temperature 260°C or below (package surface temperature)

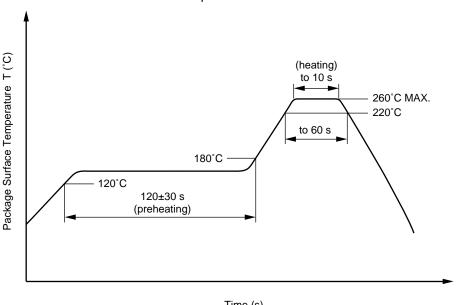
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



#### Time (s)

#### (2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

#### (3) Soldering by soldering iron

• Peak temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

## CEL California Eastern Laboratories PS2562-1,PS2562L-1,PS2562L1-1,PS2562L2-1

#### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

#### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

#### ★ 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

## **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

## SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter   | Symbol   | Speck            | Unit              |
|---|----------|------------------|-------------------|
| Application classification (DIN VDE 0109)   |          | IV               |                   |
| for rated line voltages ≤ 300 Vr.m.s.<br>for rated line voltages ≤ 600 Vr.m.s.  |          | III              |                   |
| Climatic test class (DIN IEC 68 Teil 1/09.80)   |          | 55/100/21        |                   |
| Dielectric strength maximum operating isolation voltage   |          |                  |                   |
| Test voltage (partial discharge test procedure a for type test and random test)                                       | UIORM    | 890              | V <sub>peak</sub> |
| $U_{pr} = 1.2 \times U_{IORM}$ , $P_d < 5 pC$   | Upr      | 1 068            | V <sub>peak</sub> |
| Test voltage (partial discharge test procedure b for all devices test) $U_{pr} = 1.6 \times U_{IORM}, \ P_d < 5 \ pC$ | Upr      | 1 424            | V <sub>peak</sub> |
| Highest permissible overvoltage   | Utr      | 8 000            | V <sub>peak</sub> |
| Degree of pollution (DIN VDE 0109)  |          | 2                |                   |
| Clearance distance  |          | > 7.0            | mm                |
| Creepage distance   |          | > 7.0            | mm                |
| Comparative tracking index (DIN IEC 112/VDE 0303 part 1)  | СТІ      | 175              |                   |
| Material group (DIN VDE 0109)   |          | III a            |                   |
| Storage temperature range   | Tstg     | -55 to +150      | °C                |
| Operating temperature range   | TA       | -55 to +100      | °C                |
| Isolation resistance, minimum value   |          |                  |                   |
| $V_{IO} = 500 \text{ V dc}$ at $T_A = 25 \text{ °C}$  | Ris MIN. | 10 <sup>12</sup> | Ω                 |
| Vio = 500 V dc at TA MAX. at least 100 °C   | Ris MIN. | 10 <sup>11</sup> | Ω                 |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve)                             |          |                  |                   |
| Package temperature   | Tsi      | 175              | °C                |
| Current (input current I <sub>F</sub> , Psi = 0)  | Isi      | 400              | mA                |
| Power (output or total power dissipation)   | Psi      | 700              | mW                |
| Isolation resistance  |          |                  |                   |
| $V_{IO} = 500 \text{ V dc at T}_A = 175 \text{ °C (Tsi)}$   | Ris MIN. | 10 <sup>9</sup>  | Ω                 |

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M8E 00.4-0110

## CEL California Eastern Laboratories PS2562-1,PS2562L-1,PS2562L1-1,PS2562L2-1

#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

#### ▶For further information, please contact

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4590 Patrick Henry Drive Santa Clara, CA 95054-1817 Telephone: (408) 919-2500

Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance per RoHS | Concentration Limit per RoHS (values are not yet fixed) |                    | on contained<br>devices |  |
|-------------------------------|---|--------------------|-------------------------|--|
| Lead (Pb)                     | < 1000 PPM  | -A<br>Not Detected | -AZ<br>(*)              |  |
| Mercury                       | < 1000 PPM  | Not Detected       |                         |  |
| Cadmium                       | < 100 PPM   | Not Detected       |                         |  |
| Hexavalent Chromium           | < 1000 PPM  | Not Detected       |                         |  |
| PBB < 1000 PPM Not [          |   | Not De             | Detected                |  |
| PBDE                          | < 1000 PPM  | Not Detected       |                         |  |

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## CEL:

<u>PS2562L-1-E3-A</u> <u>PS2562L-1-E3-L-A</u> <u>PS2562L2-K-A</u> <u>PS2562L-1-V-E3-A</u> <u>PS2562L-1</u> <u>PS2562L-4</u> <u>PS2562L-4</u> <u>PS2562L-4</u>